

## **EXHIBIT B**

**to**

### **Microsoft's Reply in Support of its Motion to Stay Litigation Pending Reexaminations**

Patent-in-Suit	New Art in Reexamination – Not Considered In Original Examination
5,999,084	<ul style="list-style-type: none"> <li>• Kazuhiro Matsumoto, Japanese Laid-Open Utility Model Publication S61-103836</li> <li>• U.S. Patent No. Re. 34,095</li> </ul>
6,102,802	<ul style="list-style-type: none"> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H5-87760</li> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H05-326217</li> <li>• Yasushi Kawashima, Japanese Patent Application Laid-Open Disclosure No. H1-40545</li> <li>• Shingo Yamaoka, Japanese Patent Application Laid-Open Disclosure No. H7-112073</li> <li>• U.S. Patent No. 3,806,471</li> <li>• U.S. Patent No. 4,489,302</li> <li>• U.S. Patent No. 5,207,426</li> <li>• U.S. Patent No. 5,164,697</li> </ul>
6,135,886	<ul style="list-style-type: none"> <li>• Hitoshi Furukawa et al., Japanese Laid-Open Utility Model Application No. H06-56740</li> <li>• Hitoshi Furukawa et al., Japanese Laid-Open Patent Application Publication No. H05-326217</li> <li>• U.S. Patent No. 4,749,878</li> <li>• U.S. Patent No. 4,775,574</li> <li>• U.S. Patent No. 5,164,697</li> <li>• U.S. Patent No. 5,557,299</li> <li>• U.S. Patent No. 6,004,210</li> </ul>
6,208,271	<ul style="list-style-type: none"> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H5-87760</li> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H05-326217</li> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H06-056740</li> <li>• Yasufumi Asano, Japanese Patent Application Laid-Open Disclosure No. H01-62627</li> <li>• Shiro Tanami, Japanese Patent Application Laid-Open Disclosure No. H05-190051</li> <li>• Junichi Terajima, Japanese Patent Application Laid-Open Disclosure No. H7-302159</li> <li>• Seiichi Sakurai, Japanese Patent Application Laid-Open Disclosure</li> </ul>

	<p>No. H06-154422</p> <ul style="list-style-type: none"> <li>• Tamotsu Yamamoto, Japanese Patent Application Laid-Open Disclosure No. H08-222070</li> <li>• U.S. Patent No. 4,489,302</li> <li>• U.S. Patent No. 5,164,697</li> <li>• U.S. Patent No. 5,231,386</li> <li>• U.S. Patent No. 5,377,173</li> <li>• U.S. Patent No. 6,004,210</li> </ul>
6,222,525	<ul style="list-style-type: none"> <li>• Hitoshi Furukawa <i>et al.</i>, Japanese Patent Application Laid-Open Disclosure No. H5-87760</li> <li>• Kazuhiro Matsumoto, Japanese Laid-Open Utility Model Publication S61-103836</li> <li>• U.S. Patent No. 4,246,452</li> <li>• U.S. Patent No. 4,527,021</li> <li>• U.S. Patent No. 5,164,697</li> </ul>
6,343,991	<ul style="list-style-type: none"> <li>• Yasufumi Asano, Japanese Laid Open Patent Application No. H1-62627</li> <li>• Yasushi Kawashima, Japanese Patent Application Laid-Open Disclosure No. H1-40545</li> <li>• Shiro Tanami, et al, Japanese Laid Open Patent Publication No. H05-190051</li> <li>• Hitoshi Furukawa, et al, Japanese Patent Application Laid-Open Disclosure No. H05-326217</li> <li>• Hitoshi Furukawa, et al, Japanese Patent Application Laid-Open Model Application No. H6-56740</li> <li>• Seiichi Sakurai, et al, Japanese Laid-Open Patent Application No. H06-154422</li> <li>• Shingo Yamaoka, Japanese Patent Application Laid-Open Disclosure No. H7-112073</li> <li>• Tamotsu Yamamoto, Japanese Laid Open Patent Application H08-222070</li> <li>• U.S. Patent No. 4,314,227</li> <li>• U.S. Patent No. 4,315,238</li> <li>• U.S. Patent No. 4,419,653</li> <li>• U.S. Patent No. 4,490,587</li> <li>• U.S. Patent No. 4,604,509</li> <li>• U.S. Patent No. 4,775,574</li> <li>• U.S. Patent No. 5,164,697</li> <li>• U.S. Patent No. 5,252,971</li> <li>• U.S. Patent No. 5,296,837</li> </ul>

6,344,791	<ul style="list-style-type: none"> <li>• Keith Knox, UK Published Patent Specification No. 1 412 298</li> <li>• Roger Meleard et al, UK Published Patent Application No. 2 156 588 A</li> <li>• Michihito Kaneko et al, Japanese Laid-Open Utility Model Publication No. S61-100844</li> <li>• Kazuhiro Matsumoto et al, Japanese Laid-Open Utility Model Publication No. S61-103836</li> <li>• Yoichi Kawashima, Japanese Laid-Open Utility Model Application No. H3-61304</li> <li>• Shiro Tanami, Japanese Laid-Open Patent Application No. H5-304007</li> <li>• Hitoshi Furukawa, et al, Japanese Patent Application Laid-Open Model Application No. H6-56740</li> <li>• Shingo Yamaoka, Japanese Patent Application Laid-Open Disclosure No. H7-112073</li> <li>• U.S. Patent No. 3,643,041</li> <li>• U.S. Patent No. 4,604,509</li> <li>• U.S. Patent No. 5,231,386</li> <li>• U.S. Patent No. Re. 34,095</li> </ul>
6,347,997	<ul style="list-style-type: none"> <li>• Kazuhiro Matsumoto, Japanese Patent Application Publication No. S61-103836</li> <li>• Yasuhi Kawashima <i>et al.</i>, Japanese Patent Application Publication No. S62-82090</li> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H05-326217</li> <li>• Atsunori Himoto et al., European Patent Application EP 0 835676 A1</li> <li>• U.S. Patent No. 4,766,271</li> <li>• U.S. Patent No. 5,164,697</li> <li>• U.S. Patent No. 5,207,426</li> <li>• U.S. Patent No. 5,669,818</li> <li>• U.S. Patent No. Re. 34,095</li> </ul>
6,351,205	<ul style="list-style-type: none"> <li>• Matsumoto et al., Japanese Laid Open Utility Model Application No. JP S61-103836</li> <li>• Kaneko et al., Japanese Laid Open Utility Model Application No. JP S61-100844</li> <li>• Knox, Great Britain Patent No. 1 412 298</li> <li>• Kawashima et al., Japanese Examined Utility Model Publication H1-40545</li> <li>• U.S. Patent No. 4,353,552</li> </ul>

6,400,303	<ul style="list-style-type: none"> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H5-87760</li> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H05-326217</li> <li>• Hitoshi Furukawa, Japanese Patent Application Laid-Open Disclosure No. H06-056740</li> <li>• Yasufumi Asano, Japanese Patent Application Laid-Open Disclosure No. H01-62627</li> <li>• Shiro Tanami, Japanese Patent Application Laid-Open Disclosure No. H05-190051</li> <li>• Junichi Terajima, Japanese Patent Application Laid-Open Disclosure No. H7-302159</li> <li>• Seiichi Sakurai, Japanese Patent Application Laid-Open Disclosure No. H06-154422</li> <li>• Tamotsu Yamamoto, Japanese Patent Application Laid-Open Disclosure No. H08-222070</li> <li>• U.S. Patent No. 5,231,386</li> <li>• U.S. Patent No. 6,004,210</li> </ul>
6,563,415	<ul style="list-style-type: none"> <li>• Matsumoto et al., Japanese Laid Open Utility Model Application No. JP S61-103836</li> <li>• Kaneko et al., Japanese Laid Open Utility Model Application No. JP S61-100844</li> <li>• Knox, Great Britain Patent No. 1 412 298</li> <li>• Furukawa et al., Japanese Laid Open Patent Application No. JP5-326217</li> <li>• U.S. Patent No. Re. 34,095</li> <li>• U.S. Patent No. 5,046,739</li> </ul>
6,906,700	<ul style="list-style-type: none"> <li>• Sega Enterprises, Ltd., "Sega Saturn™ 3D Control Pad" instruction manual</li> <li>• Teiyu Goto, <i>et al.</i>, European Patent Application EP 0 867212 A1</li> <li>• Sony Computer Entertainment Inc., "PlayStation® Instruction Manual SCPH-7000," SONY Publication No. 3-861-343-05(1)</li> <li>• U.S. Patent No. 6,002,594</li> </ul>